Variant: 001
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PMP10478 REV B Bill of Materials

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	!PCB1	1		PMP10478	Any	Printed Circuit Board	
2	C1, C7, C11, C16, C17	5	0.1uF	C1005X5R0J104K	TDK	CAP, CERM, 0.1uF, 6.3V, +/-10%, X5R, 0402	0402
3	C2	1	15uF	EEUED2G150	Panasonic	CAP, AL, 15uF, 400V, +/-20%, 1.909859 ohm, TH	12.5x20
4	C3	1	47uF	EEUED2G470S	Panasonic	CAP, AL, 47uF, 400V, +/-20%, 0.609529 ohm, TH	18x20
5	C4, C18	2	47uF	GRM31CR61A476KE15L	MuRata	CAP, CERM, 47uF, 10V, +/-10%, X5R, 1206	1206
6	C5	1	0.1uF	VJ1808Y104KXPAT5Z	Vishay-Vitramon	CAP, CERM, 0.1uF, 250V, +/-10%, X7R, 1808	1808
7	C6, C8, C15, C19	4	1uF	GRM155R61A105KE15D	MuRata	CAP, CERM, 1uF, 10V, +/-10%, X5R, 0402	0402
8	C9	1	4700pF	VY2472M49Y5US63V7	Vishay-Bccomponents	CAP, CERM, 4700 pF, 440 V, +/- 20%, Y5U, TH, 12.5x5mm	TH, 12.5x5mm
9	C10	1	0.22uF	B32922C3224M	EPCOS Inc	CAP, Film, 0.22uF, 630V, +/-20%, TH	B32922_12.5mm
10	C12, C13, C14	3	470uF	RL80J471MDNASQKX	Nichicon	CAP, AL, 470 µF, 6.3 V, +/- 20%, 0.008 ohm, TH	D8xL8
11	C20	1	4.7uF	GRM21BR61E475MA12L	MuRata	CAP, CERM, 4.7 µF, 25 V, +/- 20%, X5R, 0805	0805
12	C21	1	0.01uF	GRM155R71H103KA88D	MuRata	CAP, CERM, 0.01 µF, 50 V, +/- 10%, X7R, 0402	0402
13	C22	1	0.22uF	GRM155R71C224KA12D	MuRata	CAP, CERM, 0.22 µF, 16 V, +/- 10%, X7R, 0402	0402
14	C100	1	0.022uF	GRM155R71H223KA12D	MuRata	CAP, CERM, 0.022 µF, 50 V, +/- 10%, X7R, 0402	0402
15	C101	1	10uF	GRM21BR61C106KE15L	MuRata	CAP, CERM, 10 µF, 16 V, +/- 10%, X5R, 0805	0805
16	D1	1	1.1V	DF1506S-T	Diodes Inc.	Diode, Switching-Bridge, 600V, 1.5A, DF-S	DF-S
17	D2	1	110V	SMCJ110A-TP	Micro Commercial Components	TVS DIODE 110VWM 177VC SMC	SMC
18	D3	1	800V	US1K-13-F	Diodes Inc.	Diode, Fast Rectifier, 800 V, 1 A, SMA	SMA
19	D4	1	200V	BAS21-TP	Micro Commercial Components	Diode, P-N, 200V, 200A, SOT-23	SOT-23
20	D100	1	30V	BAT54SWT1G	Fairchild Semiconductor	Diode, Schottky, 30 V, 0.2 A, SOT-323	SOT-323
21	F1	1		0452003.	Littelfuse	Fuse, 3A, 125V, SMD	SloBlo452
22	J1, J2	2		1002-021-01000	CnC Tech	Connector, Receptable, USB Type A, Vertical, TH	Vertical USB Type A
23	L2	1	10mH	744821110	Wurth Elektronik eiSos	Coupled inductor, 10 mH, 0.7 A, 0.35 ohm, +/- 30%, TH	15 x 18 x 7.5mm
24	Q1	1	650V	SPP07N60C3	Infineon Technologies	MOSFET, N-CH, 650V, 7.3A, TO-220AB	TO-220AB
25	Q2	1	30V	CSD17312Q5	Texas Instruments	MOSFET, N-CH, 30 V, 100 A, SON 5x6mm	SON 5x6mm
26	R1	1	51	CRCW251251R0JNEG	Vishay-Dale	RES, 51, 5%, 1 W, 2512	2512
27	R2	1	20.0k	CRCW040220K0FKED	Vishay-Dale	RES, 20.0 k, 1%, 0.063 W, 0402	0402
28	R3, R101	2	10.0k	CRCW040210K0FKED	Vishay-Dale	RES, 10.0k ohm, 1%, 0.063W, 0402	0402
29	R4	1	499k	CRCW0402499KFKED	Vishay-Dale	RES, 499k ohm, 1%, 0.063W, 0402	0402
30	R5	1	10	CRCW040210R0JNED	Vishay-Dale	RES, 10, 5%, 0.063 W, 0402	0402
31	R6	1	66.5k	CRCW040266K5FKED	Vishay-Dale	RES, 66.5 k, 1%, 0.063 W, 0402	0402
32	R7	1	10	CRCW040210R0JNED	Vishay-Dale	RES, 10 ohm, 5%, 0.063W, 0402	0402
33	R8, R19, R20	3	1.00k	CRCW04021K00FKED	Vishay-Dale	RES, 1.00 k, 1%, 0.063 W, 0402	0402
34	R9	1	22.6k	CRCW040222K6FKED	Vishay-Dale	RES, 22.6 k, 1%, 0.063 W, 0402	0402
35	R10	1	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402
36	R12	1	0.51	CRM1206-FX-R510ELF	Bourns	RES, 0.51, 1%, 0.5 W, 1206	1206
37	R13	1	2.00k	CRCW04022K00FKED	Vishay-Dale	RES, 2.00 k, 1%, 0.063 W, 0402	0402
38	R14, R17	2	499	CRCW0402499RFKED	Vishay-Dale	RES, 499, 1%, 0.063 W, 0402	0402
39	R15	1	23.2k	CRCW040223K2FKED	Vishay-Dale	RES, 23.2k ohm, 1%, 0.063W, 0402	0402
40	R16	1	200k	CRCW0402200KFKED	Vishay-Dale	RES, 200k ohm, 1%, 0.063W, 0402	0402
41	R21	1	30.1k	CRCW040230K1FKED	Vishay-Dale	RES, 30.1 k, 1%, 0.063 W, 0402	0402
42	R100	1	4.7	CRCW12064R70JNEA	Vishay-Dale	RES, 4.7, 5%, 0.25 W, 1206	1206
43	T1	1	300 uH	G144093LF	GCI Technologies	Transformer, 300 uH, TH	TH, 30.1x23.4mm
44	TP1	1	Black	5001	Keystone	Test Point, Miniature, Black, TH	Black Miniature Testpoint
45	TP2	1	White	5002	Keystone	Test Point, Miniature, White, TH	White Miniature Testpoint
46	U1	1		TMP300BIDCKR	Texas Instruments	1.8V, Resistor-Programmable TEMPERATURE SWITCH and ANALOG OUT TEMPERATURE SENSOR, DCK0006A	DCK0006A
47	U2	1		TPS2513DBV	Texas Instruments	DUAL CHANNEL AUTO DETECT USB CHARGING CONTROLLER, DBV0006A	DBV0006A
48	U3, U6	2		TPD2E001DRLR	Texas Instruments	Low-Capacitance + / - 15 kV ESD-Protection Array for High-Speed Data Interfaces, 2 Channels, -40 to +85 degC, 5-pin SOT (DRL), Green (RoHS & no Sb/Br)	DRL0005A
49	U4	1		TPS2561ADRC	Texas Instruments	DUAL CHANNEL PRECISION ADJUSTABLE CURRENT-LIMITED POWER SWITCHES, DRC0010A	DRC0010A
50	U5	1		UCC28740DR	Texas Instruments	Constant-Voltage, Constant-Current Flyback Controller Using Opto-Coupler Feedback, D0007A	D0007A
51	U7	1		UCC24610DRB	Texas Instruments	GREEN Rectifier Controller Device, DRB0008A	DRB0008A
52	U8	1		VOS617A-7X001T	Vishay-Semiconductor	OptoCoupler, Phototransitor, 80-160%, SSOP-4	7x2.12x2.6mm
53	U9	1		TL431AIDBZ	Texas Instruments	PRECISION PROGRAMMABLE REFERENCE, DBZ0003A	DBZ0003A

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